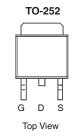
## N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>		
60	0.0025 at V <sub>GS</sub> = 10 V	150		
	0.0051 at V <sub>GS</sub> = 4.5 V	75		



FEATURES	

- DT-Trench Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)							
Parameter		Symbol	Limit	Unit			
Gate-Source Voltage		V <sub>GS</sub>	± 20	V			
Continuous Drain Current ( $T_1 = 175 \ ^{\circ}C$ ) <sup>b</sup>	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1-	150	-			
Continuous Drain Current $(T_J = 175^{\circ}C)^2$	T <sub>C</sub> = 100 °C	- I <sub>D</sub>	85 <sup>a</sup>				
Pulsed Drain Current		I <sub>DM</sub>	600	A			
Continuous Source Current (Diode Conduction)		۱ <sub>S</sub>	120ª				
Avalanche Current		I <sub>AS</sub>	130				
Single Avalanche Energy (Duty Cycle $\leq$ 1 %)	L = 0.1 mH	E <sub>AS</sub>	289	mJ			
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	205	W			
	T <sub>A</sub> = 25 °C	· D	5.6 <sup>b</sup>	vv			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C			

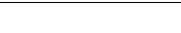
THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manianan harating ta Asekinga	$t \le 10 \text{ sec}$	R <sub>thJA</sub>	9	15	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		15	45	
Maximum Junction-to-Case		R <sub>thJC</sub>	0.95	1.5	

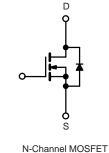
Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c.  $t \leq 10$  s.









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<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static	<u> </u>						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ 60				V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	-	3	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$	0 V		1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$			50	μA	
		$V_{DS} = 48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$			250		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	150			А	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0025	0.0033	Ω	
	P	$V_{GS}$ = 10 V, I <sub>D</sub> =20 A, T J = 125 °C		0.0032	0.0040		
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> =15 A, T <sub>J</sub> = 175 °C		0.0039	0.0048		
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		0.0051	0.0062		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	$V_{DS} = 48 \text{ V}, I_{D} = 20 \text{ A}$		166		S	
Dynamic	•						
Input Capacitance	C <sub>iss</sub>			10120		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 48 V, f = 1 MHz		1588			
Reverse Transfer Capacitance	C <sub>rss</sub>			157			
Total Gate Charge <sup>c</sup>	Qg			75	89	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 48 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		15			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			19			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			18			
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 48 \text{ V}, \text{ R}_{L} = 0.6 \Omega$ $I_{D} \cong 20 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{g} = 2.5 \Omega$		32		ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			66			
Fall Time <sup>c</sup>	t <sub>f</sub>			13			
Source-Drain Diode Ratings and Ch	aracteristics (	T <sub>C</sub> = 25 °C)					
Pulsed Current	I <sub>SM</sub>				600	А	
Diode Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = 20 A, V <sub>GS</sub> = 0 V			1.25	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/µs		73		ns	

Notes:

a. For design aid only; not subject to production testing.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

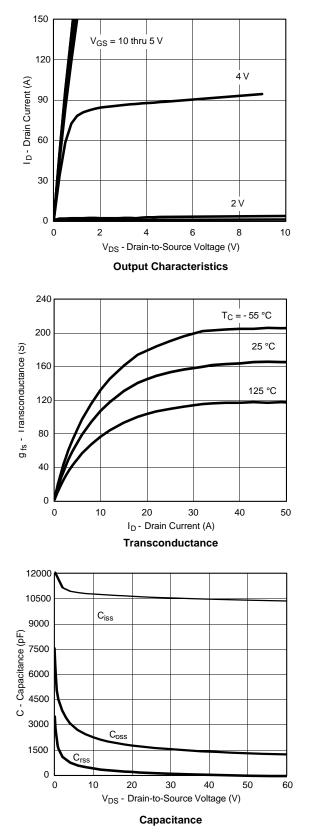
c. Independent of operating temperature.

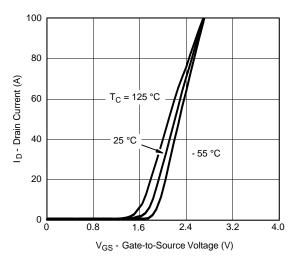
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



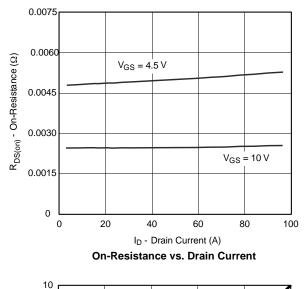
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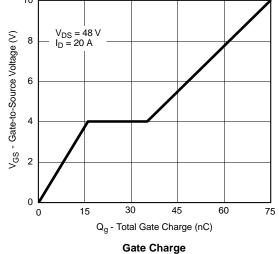
#### TYPICAL CHARACTERISTICS (25 °C unless noted)





Transfer Characteristics

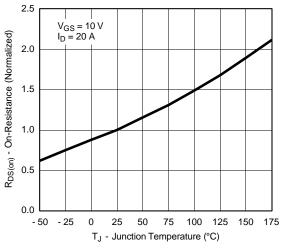




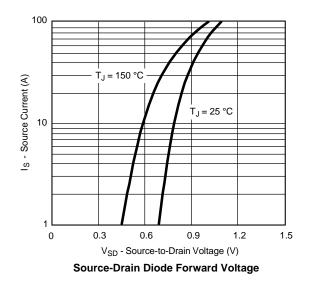


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#### TYPICAL CHARACTERISTICS (25 °C unless noted)



**On-Resistance vs. Junction Temperature** 

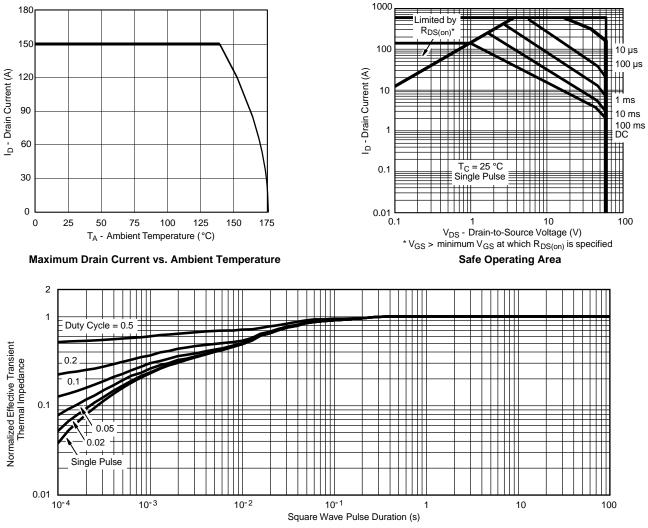




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Normalized Thermal Transient Impedance, Junction-to-Case

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